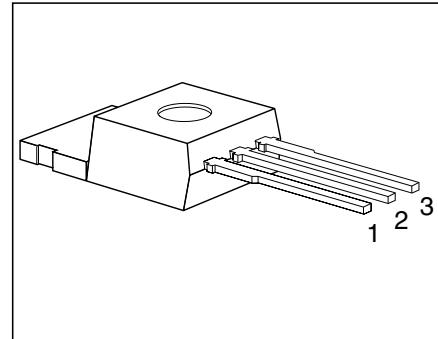


Features

- N channel
- Enhancement mode
- Temperature sensor with thyristor characteristic
- The drain pin is electrically shorted to the tab



Pin	1	2	3
	G	D	S

Type	V _{DS}	I _D	R _{DS(on)}	Package	Ordering Code
BTS 114A	50 V	17 A	0.10 Ω	TO-220AB	C67078-S5000-A2

Maximum Ratings

Parameter	Symbol	Values	Unit
Drain-source voltage	V _{DS}	50	V
Drain-gate voltage, R _{GS} = 20 kΩ	V _{DGR}	50	
Gate-source voltage	V _{GS}	± 20	
Continuous drain current, T _C = 27 °C	I _D	17	
ISO drain current T _C = 85 °C, V _{GS} = 10 V, V _{DS} = 0.5 V	I _{D-ISO}	3.8	A
Pulsed drain current, T _C = 25 °C	I _{D puls}	68	
Short circuit current, T _j = -55 ... + 150 °C	I _{SC}	37	
Short circuit dissipation, T _j = -55 ... + 150 °C	P _{SCmax}	550	
Power dissipation	P _{tot}	50	W
Operating and storage temperature range	T _j , T _{stg}	-55 ... + 150	
DIN humidity category, DIN 40 040	-	E	
IEC climatic category, DIN IEC 68-1	-	55/150/56	
Thermal resistance Chip-case	R _{th JC}	≤ 2.5	K/W
Chip-ambient	R _{th JA}	≤ 75	

Electrical Characteristics

at $T_j = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Static Characteristics

Drain-source breakdown voltage $V_{GS} = 0, I_D = 0.25 \text{ mA}$	$V_{(\text{BR})\text{DSS}}$	50	—	—	V
Gate threshold voltage $V_{GS} = V_{DS}, I_D = 1.0 \text{ mA}$	$V_{GS(\text{th})}$	2.5	3.0	3.5	
Zero gate voltage drain current $V_{GS} = 0 \text{ V}, V_{DS} = 50 \text{ V}$	I_{DSS}				μA
		$T_j = 25^\circ\text{C}$	0.1	1.0	
		$T_j = 125^\circ\text{C}$	10	100	
Gate-source leakage current $V_{GS} = 20 \text{ V}, V_{DS} = 0$	I_{GSS}				
		$T_j = 25^\circ\text{C}$	10	100	nA
		$T_j = 150^\circ\text{C}$	2	4	μA
Drain-source on-state resistance $V_{GS} = 10 \text{ V}, I_D = 9.0 \text{ A}$	$R_{DS(\text{on})}$	—	0.08	0.10	Ω

Dynamic Characteristics

Forward transconductance $V_{DS} \geq 2 \times I_D \times R_{DS(\text{on})\text{max}}, I_D = 9 \text{ A}$	g_{fs}	5.0	8.0	—	S
Input capacitance $V_{GS} = 0, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	C_{iss}	—	450	600	pF
Output capacitance $V_{GS} = 0, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	C_{oss}	—	220	350	
Reverse transfer capacitance $V_{GS} = 0, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$	C_{rss}	—	85	150	
Turn-on time t_{on} , ($t_{\text{on}} = t_{d(\text{on})} + t_r$) $V_{CC} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3.0 \text{ A}, R_{GS} = 50 \Omega$	$t_{d(\text{on})}$	—	20	30	ns
	t_r	—	40	60	
Turn-off time t_{off} , ($t_{\text{off}} = t_{d(\text{off})} + t_f$) $V_{CC} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 3.0 \text{ A}, R_{GS} = 50 \Omega$	$t_{d(\text{off})}$	—	55	70	
	t_f	—	40	60	

Electrical Characteristics (cont'd)

at $T_j = 25 \text{ }^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	

Reverse Diode

Continuous source current	I_S	—	—	17	A
Pulsed source current	I_{SM}	—	—	68	
Diode forward on-voltage $I_F = 17 \text{ A}$, $V_{GS} = 0 \text{ V}$	V_{SD}	—	1.3	1.6	V
Reverse recovery time $I_F = I_S$, $di_F/dt = 100 \text{ A}/\mu\text{s}$, $V_R = 30 \text{ V}$	t_{rr}	—	60	—	ns
Reverse recovery charge $I_F = I_S$, $di_F/dt = 100 \text{ A}/\mu\text{s}$, $V_R = 30 \text{ V}$	Q_{rr}	—	0.10	—	μC

Temperature Sensor

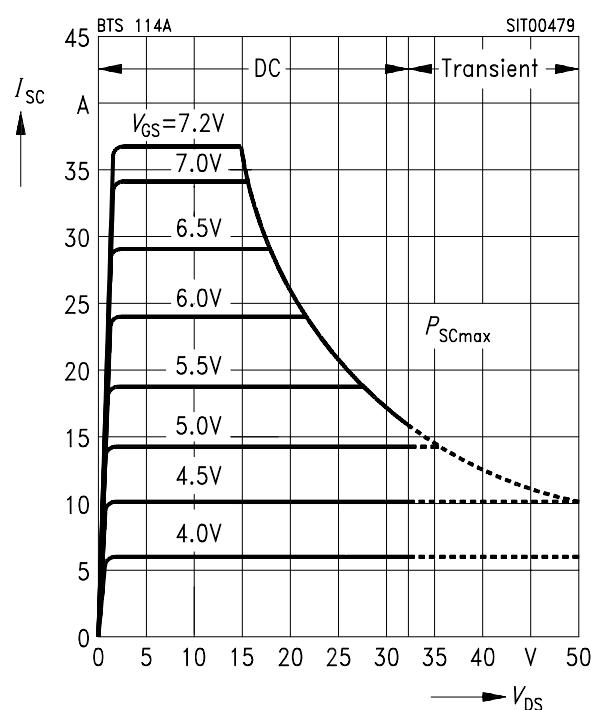
Forward voltage $I_{TS(on)} = 10 \text{ mA}$, $T_j = -55 \dots + 150 \text{ }^\circ\text{C}$ Sensor override, $t_p \leq 100 \mu\text{s}$ $T_j = -55 \dots + 160 \text{ }^\circ\text{C}$	$V_{TS(on)}$	—	1.4	1.5	V
—	—	—	10	10	
Forward current $T_j = -55 \dots + 150 \text{ }^\circ\text{C}$ Sensor override, $t_p \leq 100 \mu\text{s}$ $T_j = -55 \dots + 160 \text{ }^\circ\text{C}$	$I_{TS(on)}$	—	—	10	mA
—	—	—	600	600	
Holding current, $V_{TS(off)} = 5.0 \text{ V}$, $T_j = 25 \text{ }^\circ\text{C}$ $T_j = 150 \text{ }^\circ\text{C}$	I_H	0.05 0.05	0.1 0.2	0.5 0.3	
Switching temperature $V_{TS} = 5.0 \text{ V}$	$T_{TS(on)}$	—	—	—	${}^\circ\text{C}$
Turn-off time $V_{TS} = 5.0 \text{ V}$, $I_{TS(on)} = 2 \text{ mA}$	t_{off}	0.5	—	2.5	μs

Examples for short-circuit protection

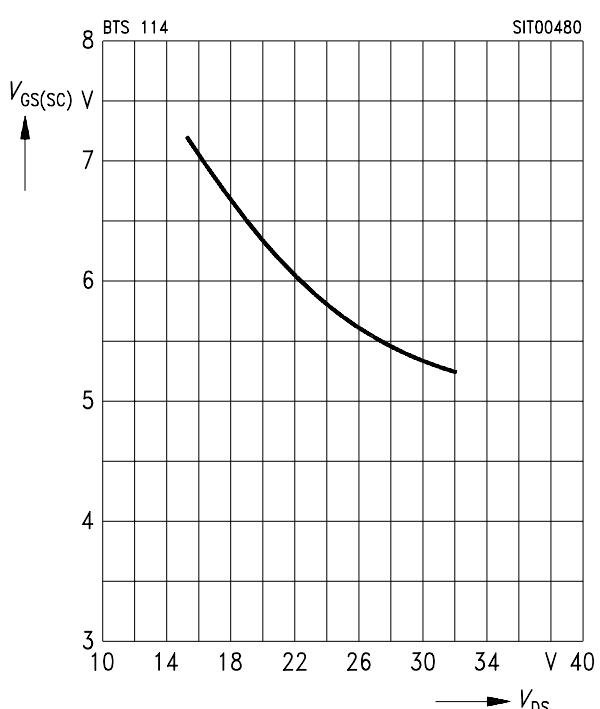
at $T_j = -55 \dots +150^\circ\text{C}$, unless otherwise specified

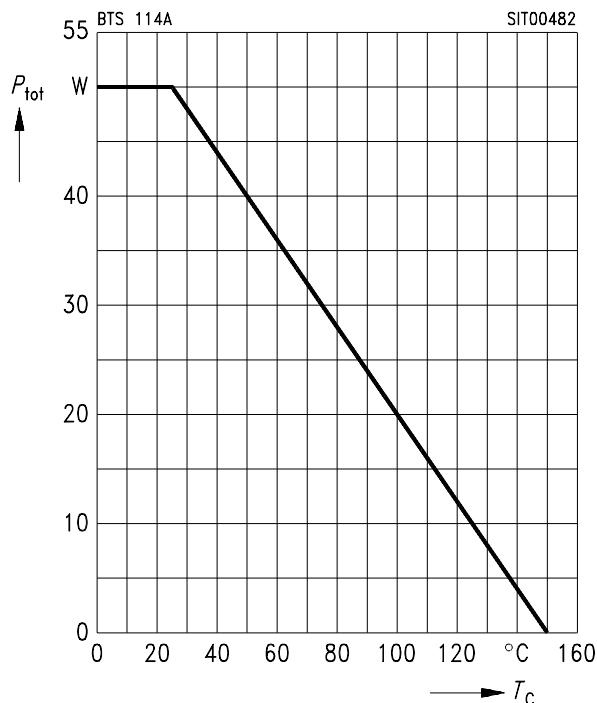
Parameter	Symbol	Examples			Unit
		1	2	-	
Drain-source voltage	V_{DS}	15	30	-	V
Gate-source voltage	V_{GS}	7.2	5.2	-	
Short-circuit current	I_{SC}	37	17	-	A
Short-circuit dissipation	P_{SC}	550	510	-	W
Response time $T_j = 25^\circ\text{C}$, before short circuit	$t_{SC(\text{off})}$	25	25	-	ms

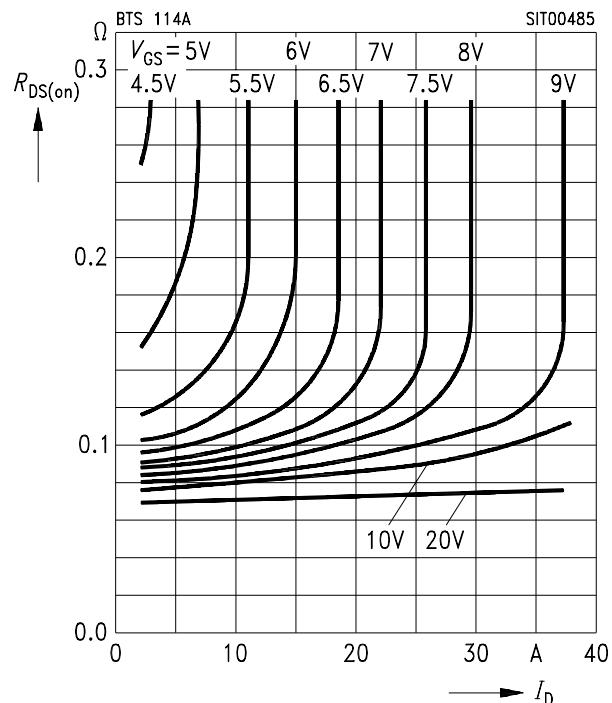
Short-circuit protection $I_{SC} = f(V_{DS})$
Parameter: V_{GS}
Diagram to determine I_{SC} for $T_j = -55 \dots +150^\circ\text{C}$

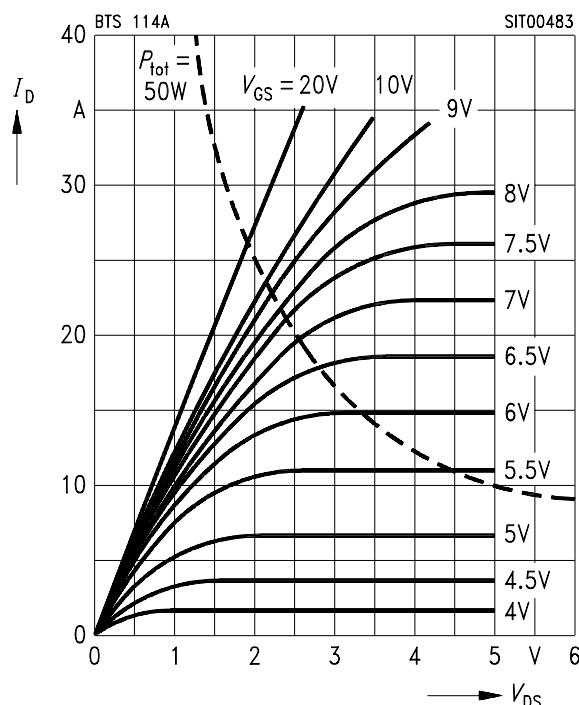


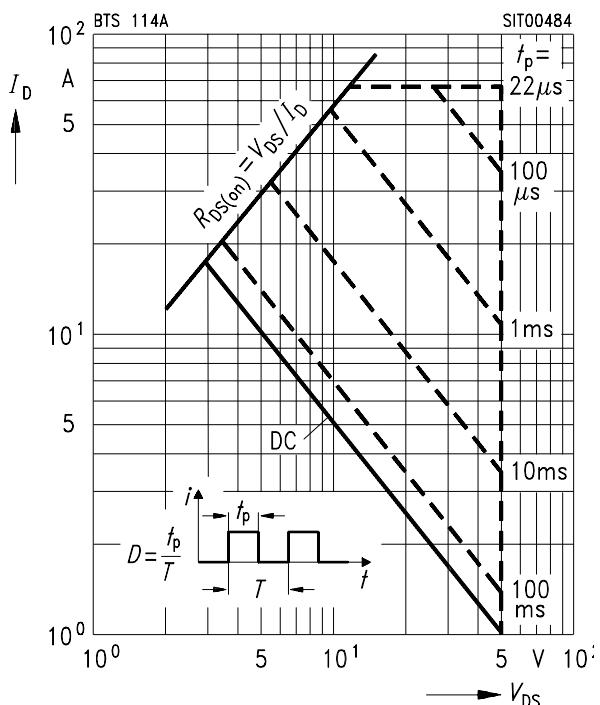
Max. gate voltage $V_{GS(SC)} = f(V_{DS})$
Parameter: $T_j = -55 \dots +150^\circ\text{C}$



Max. power dissipation $P_{\text{tot}} = f(T_C)$

Typ. drain-source on-state resistance $R_{DS(\text{on})} = f(I_D)$

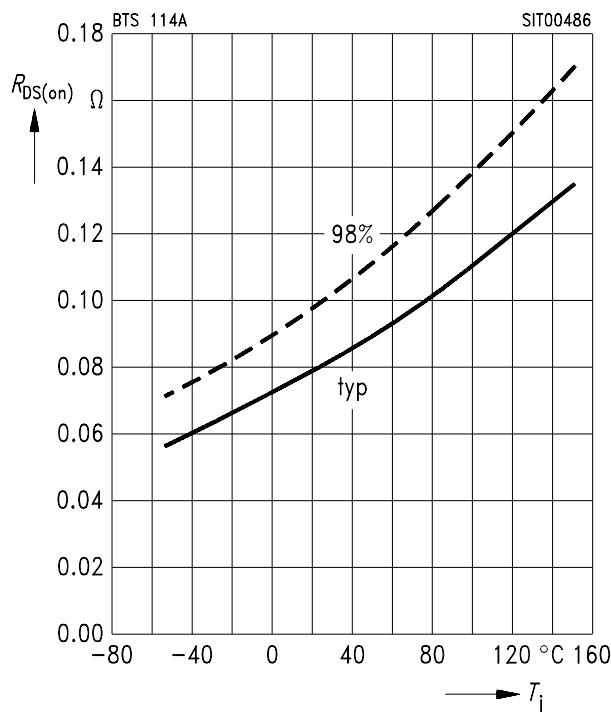
 Parameter: V_{GS}

Typical output characteristics $I_D = f(V_{DS})$

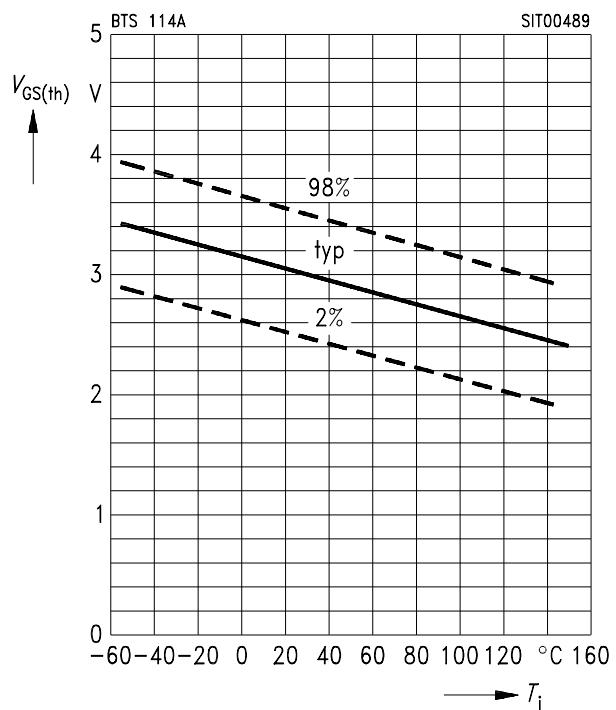
 Parameter: $t_p = 80 \mu\text{s}$

Safe operating area $I_D = f(V_{DS})$

 Parameter: $D = 0.01, T_C = 25^\circ\text{C}$


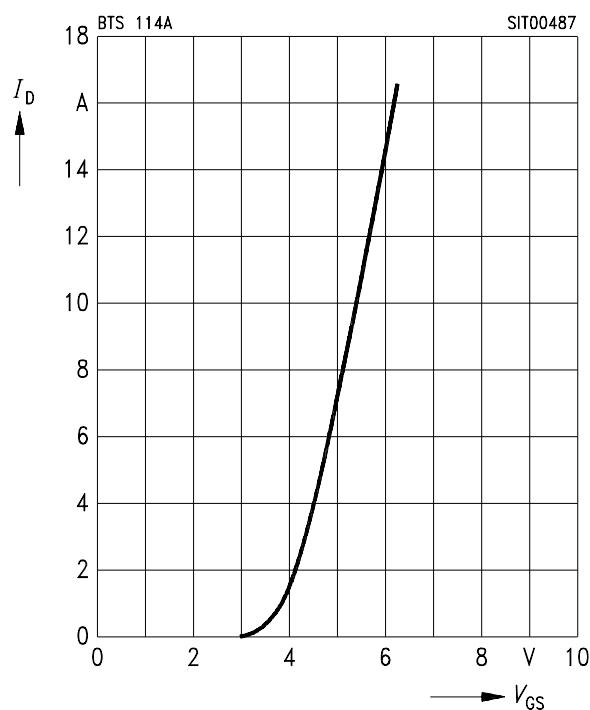
Drain-source on-state resistance

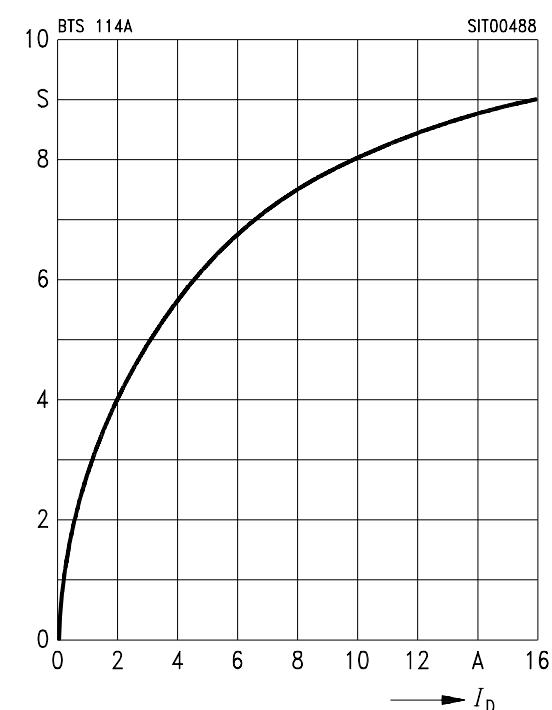
$$R_{DS(on)} = f(T_j)$$

 Parameter: $I_D = 9 \text{ A}$, $V_{GS} = 10 \text{ V}$

Gate threshold voltage $V_{GS(th)} = f(T_j)$

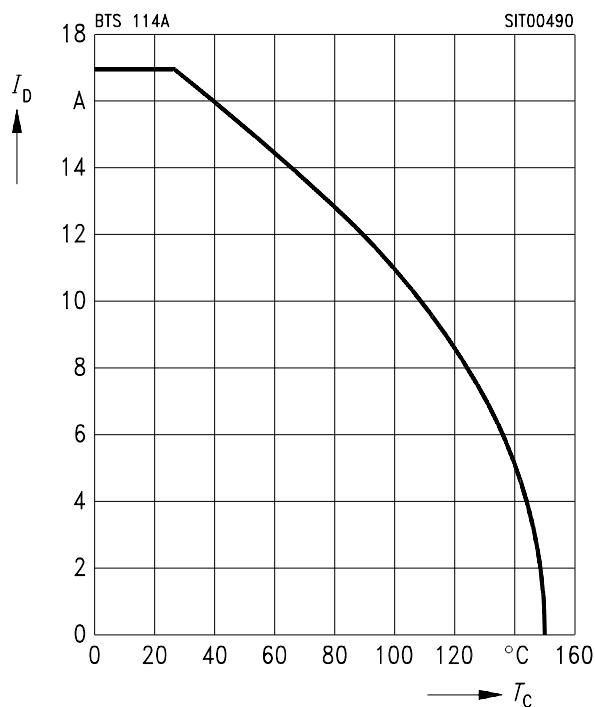
 Parameter: $V_{DS} = V_{GS}$, $I_D = -1 \text{ mA}$ (spread)

Typ. transfer characteristic

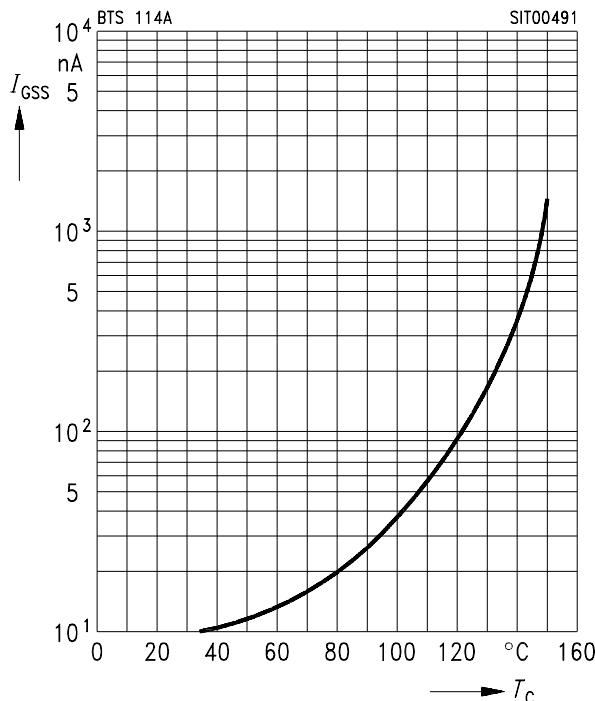
$$I_D = f(V_{GS})$$

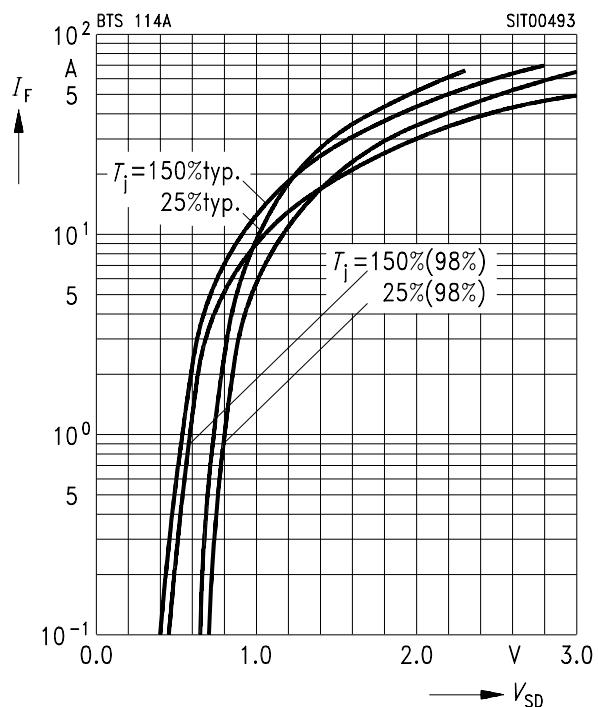
 Parameter: $t_p = 80 \mu\text{s}$, $V_{DS} = -25 \text{ V}$

Typ. transconductance $g_{fs} = f(I_D)$

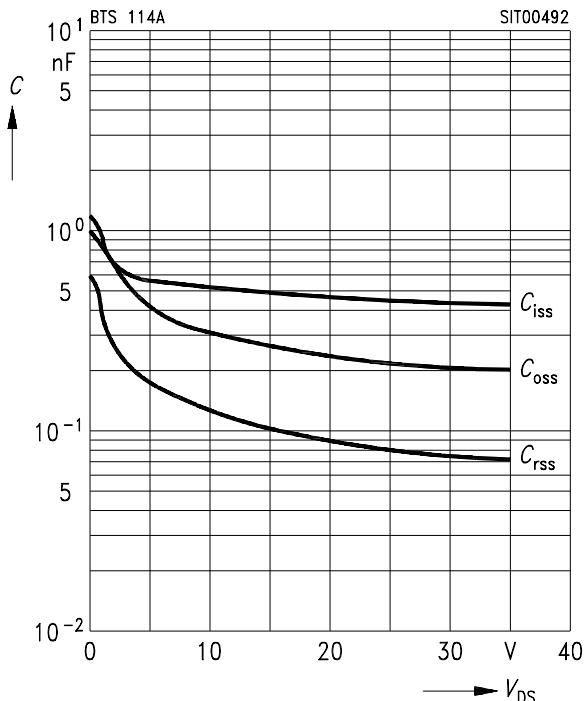
 Parameter: $t_p = 80 \mu\text{s}$, $V_{DS} = -25 \text{ V}$


Continuous drain current $I_D = f(T_C)$

Parameter: $V_{GS} \geq -10$ V

Typ. gate-source leakage current
 $I_{GSS} = f(T_C)$

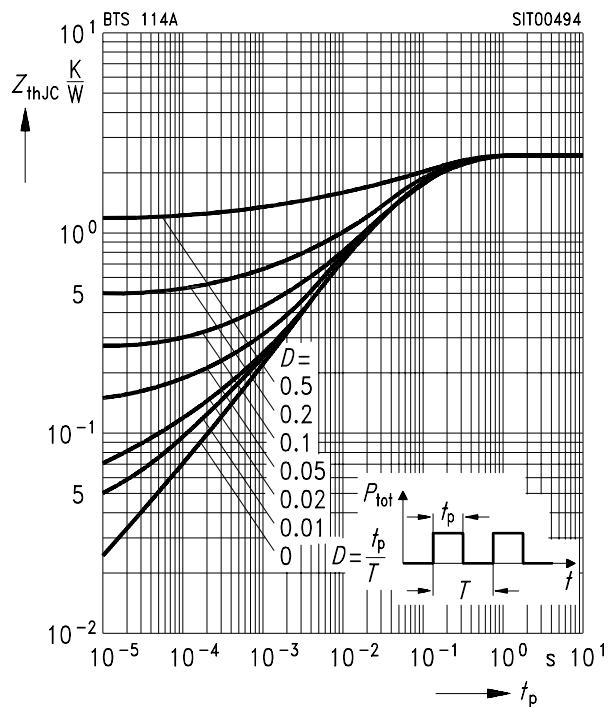
Parameter: $V_{GS} = 20$ V, $V_{DS} = 0$

Forward characteristics of reverse diode
 $I_F = f(V_{SD})$

Parameter: $T_j, t_p = 80 \mu\text{s}$ (spread)

Typ. capacitances $C = f(V_{DS})$

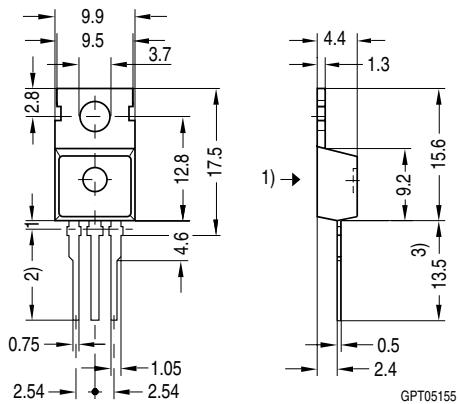
Parameter: $V_{GS} = 0$, $f = 1$ MHz


Transient thermal impedance $Z_{\text{thJC}} = f(t_p)$

Parameter: $D = t_p/T$

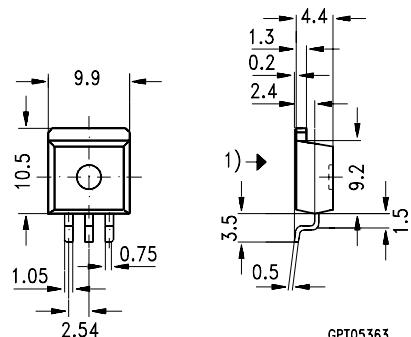


TO 220 AB
Standard

Ordering Code
C67078-S5000-A2


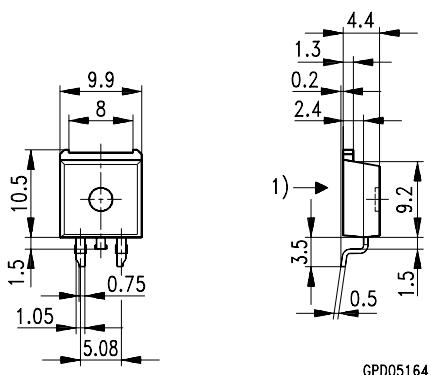
- 1) punch direction, burr max. 0.04
 2) dip tinning
 3) max. 14.5 by dip tinning press burr max. 0.05

TO 220 AB
SMD Version E3044

Ordering Code
C67078-S5000-A8


- 1) shear and punch direction no burrs this surface

TO 220 AB
Tape & reel E3045 A

Ordering Code
C67078-S5000-A11


- 1) shear and punch direction no burrs this surface

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